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 Remember to give due consideration to safety when making your circuit designs, with appropriate
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Bias Controlled Monolithic IC VHF/UHF RF Amplifier

www.DataSheet4U.com



ADE-208-984D (Z) 5th. Edition Mar. 2001

Features

- Bias Controlled Monolithic IC (No external DC biasing voltage on gate1.);
 To reduce using parts cost & PC board space.
- High |yfs|; |yfs| = 29 mS typ. (f = 1kHz)
- Low noise;

NF = 1.0 dB typ. (at f = 200 MHz), NF = 1.8 dB typ. (at f = 900 MHz)

- Withstanding to ESD;
 Build in ESD absorbing diode. Withstand up to 200V at C = 200pF, Rs = 0 conditions.
- Provide mini mold package; MPAK-4 (SOT-143Rmod)

Outline

MPAK-4



- 1. Source
- 2. Gate1
- 3. Gate2
- 4. Drain

Notes: 1. Marking is "CZ-".

2. BIC703M is individual type number of HITACHI BICMIC.

Absolute Maximum Ratings (Ta = 25°C)

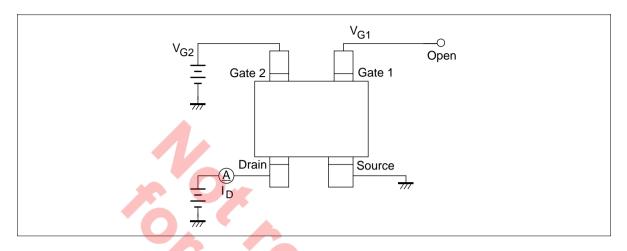
Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	6	www.DataSheet4U.com
Gate1 to source voltage	$V_{\sf G1S}$	+6 -0	V
Gate2 to source voltage	V_{G2S}	+6 -0	V
Drain current	I_{D}	30	mA
Channel power dissipation	Pch	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Electrical Characteristics (Ta = 25°C)

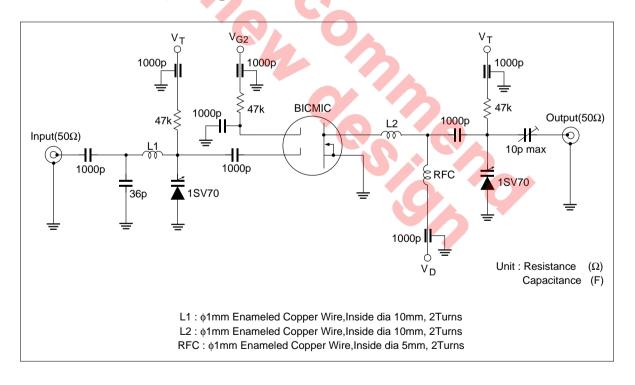
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	6	_	_	V	$I_D = 200 \mu A$ $V_{G2S} = 0, V_{G1} = open$
Gate1 to source breakdown voltage	V _{(BR)G1SS}	+6	50	_	V	$I_{G1} = +1 \text{mA}, V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	+6	_	2	V	$I_{G2} = +10 \mu A, V_{G1S} = V_{DS} = 0$
Gate2 to source cutoff current	$I_{\rm G2SS}$	_	_	+100	nA	$V_{G2S} = +5V, V_{G1S} = V_{DS} = 0$
Gate2 to source cutoff voltage	$V_{\text{G2S(off)}}$	0.8	1.1	1.5	V	$V_{DS} = 5V$, $I_{D} = 100\mu A$ $V_{G1} = open$
Drain current	I _{D(op)}	12	15	18	mA	$V_{DS} = 5V$, $V_{G2S} = 4V$ $V_{G1} = open$
Forward transfer admittance	y _{fs}	24	29	34	mS	$V_{DS} = 5V$, $I_D = 15mA$ $V_{G2S} = 4V$, $f = 1kHz$
Input capacitance	C _{iss}	1.6	2.0	2.4	pF	$V_{DS} = 5V$, $V_{G2S} = 4V$
Output capacitance	C _{oss}	0.6	1.0	1.4	pF	V _{G1} = open
Reverse transfer capacitance	C _{rss}	_	0.022	0.05	pF	f = 1MHz
Power gain	PG1	23	28	_	dB	$V_{DS} = 5V$, $V_{G2S} = 4V$ $V_{G1} = open$
Noise figure	NF1		1.0	1.8	dB	f = 200MHz
Power gain	PG2	17	22	_	dB	$V_{DS} = 5V$, $V_{G2S} = 4V$ $V_{G1} = open$
Noise figure	NF2	_	1.8	2.4	dB	f = 900MHz

Test Circuits

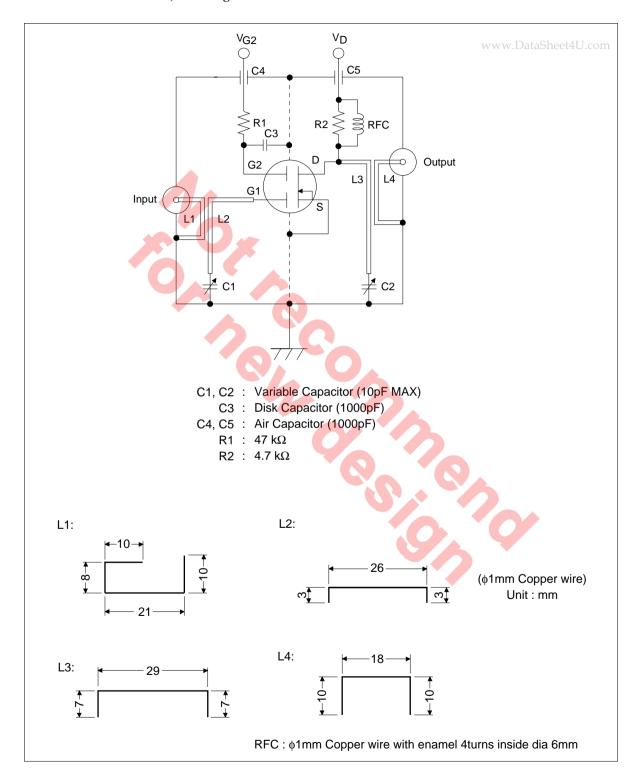
 $\bullet \ \ \textbf{DC Biasing Circuit for Operating Characteristic Items} \ (I_{D(op)}, |yfs|, Ciss, Coss, Crss, NF, PG) \\ \underline{ www.DataSheet 4U.com} \\$

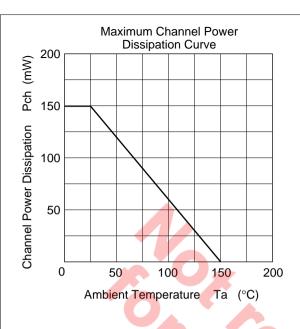


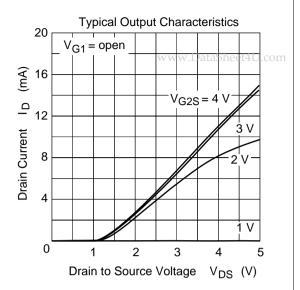
• 200 MHz Power Gain, Noise Figure Test Circuit

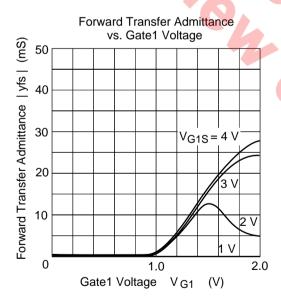


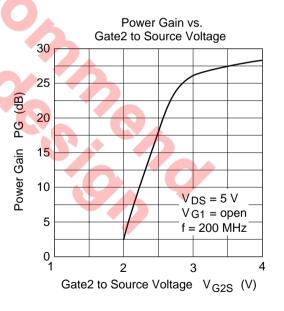
• 900 MHz Power Gain, Noise Figure Test Circuit

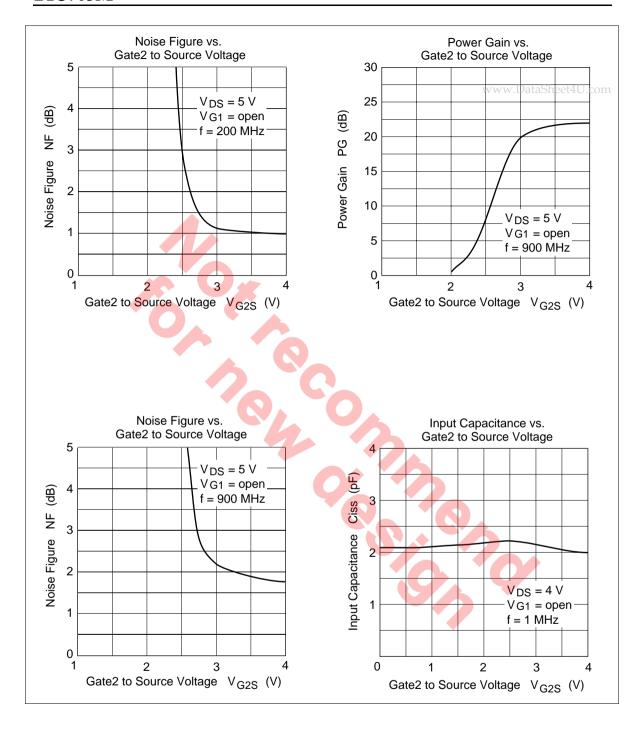


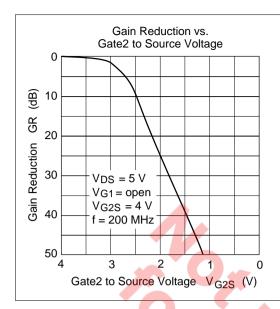


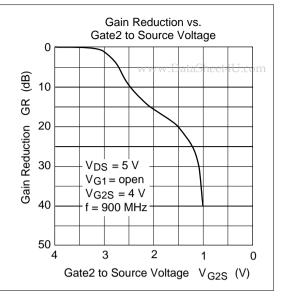


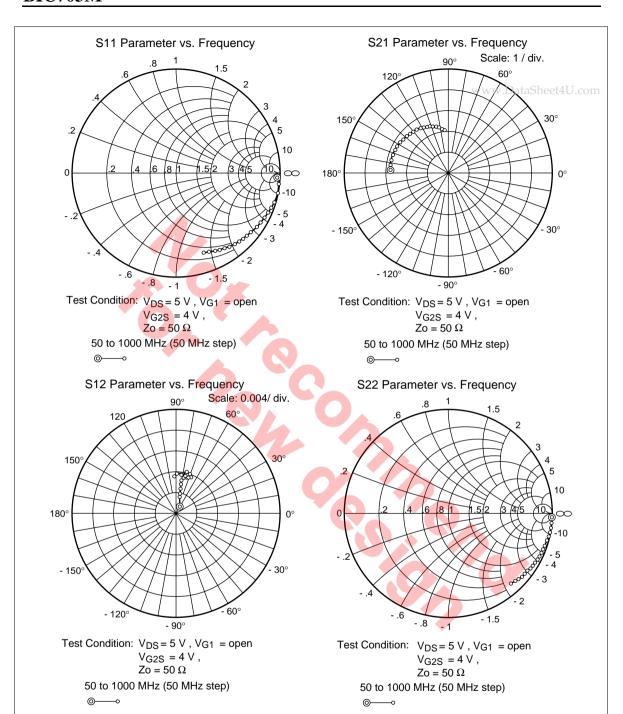








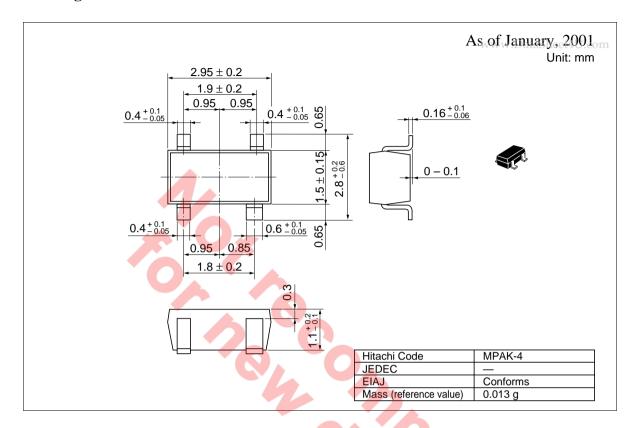




Sparameter ($(V_{DS} = 5)$	$V, V_{G2S} = 4$	V, V_{G1}	= open, $Zo = 50 \Omega$)
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	S11		S21		S12		S22	S22	
f (MHz)	MAG	ANG	MAG	ANG	MAG	ANG	MAGWW	.Da Ang eet4U.co	
50	1.000	-3.3	2.80	175.9	0.00106	58.8	0.990	-2.4	
100	0.993	-7.2	2.78	170.9	0.00171	75.7	0.992	-4.7	
150	0.991	-10.9	2.77	166.1	0.00253	75.1	0.991	-7.2	
200	0.984	-15.0	2.74	161.2	0.00356	77.4	0.987	-9.6	
250	0.978	-19.0	2.72	156.5	0.00442	78.2	0.985	-12.2	
300	0.970	-22.8	2.68	151.8	0.00485	80.0	0.982	-14.7	
350	0.958	-26.7	2.64	147.2	0.00576	74.7	0.978	-17.1	
400	0.954	-30.3	2.60	142.7	0.00642	71.7	0.973	-19.6	
450	0.945	-33.8	2.56	138.6	0.00689	73.3	0.968	-22.0	
500	0.932	-37.5	2.50	134.1	0.00712	71.8	0.963	-24.2	
550	0.920	-40.6	2.46	129.8	0.00765	70.7	0.958	-26.7	
600	0.910	-44.3	2.41	125.7	0.00804	69.9	0.952	-28.9	
650	0.900	-47.5	2.37	121.6	0.00798	69.1	0.947	-31.3	
700	0.887	-50.9	2.31	117.8	0.00787	67.8	0.942	-33.4	
750	0.870	-54.4	2.27	113.6	0.00785	70.8	0.936	-35.8	
800	0.863	-57.6	2.22	110.0	0.00758	73.3	0.929	-37.9	
850	0.853	-60.9	2.18	105.8	0.00721	75.2	0.924	-40.3	
900	0.839	-63.6	2.12	102.2	0.00694	75.8	0.917	-42.5	
950	0.827	-66.5	2.07	98.6	0.00716	88.1	0.912	-44.5	
1000	0.819	-70.1	2.04	94.9	0.00667	92.7	0.906	-46.7	
					O	Ó	70		

Package Dimensions



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